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FGD3245G2-F085 / FGB3245G2-F085

EcoSPARK®2 320mJ, 450V, N-Channel Ignition IGBT

Features

- SCIS Energy = 320mJ at T_{.I} = 25°C
- Logic Level Gate Drive
- Low Saturation Voltage
- Qualified to AEC Q101
- RoHS Compliant

Applications

- Automotive Ignition Coil Driver Circuits
- Coil On Plug Applications

General Description

The FGB3245G2-F085 and FGD3245G2 are N-channel IGBTs designed in ON Semiconductor's EcoSPARK-2 technology which helps in eliminating external protection circuitry. The technology is optimized for driving the coil in the harsh environment of automotive ignition systems and offers out-standing Vsat and SCIS Energy capability also at elevated operating temperatures. The logic level gate input is ESD protected and features an integrated gate resistor. An inte-grated zener-circuitry clamps the IGBT's collecter- to-emit-ter voltage at 450V which enables systems requiring a higher spark voltage

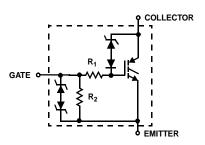


Package

Symbol







Device Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Rating	Units
BV _{CER}	Collector to Emitter Breakdown Voltage (I _C = 1mA)	450	V
BV _{ECS}	Emitter to Collector Voltage - Reverse Battery Condition (I _C = 10mA)	28	V
E _{SCIS25}	Self Clamping Inductive Switching Energy (Note 1)	320	mJ
E _{SCIS150}	Self Clamping Inductive Switching Energy (Note 2)	180	mJ
I _{C25}	Collector Current Continuous, at V _{GE} = 4.0V, T _C = 25°C	23	Α
I _{C110}	Collector Current Continuous, at V _{GE} = 4.0V, T _C = 110°C	23	Α
V_{GEM}	Gate to Emitter Voltage Continuous	±10	V
D	Power Dissipation Total, at T _C = 25°C	150	W
P_D	Power Dissipation Derating, for T _C > 25°C	1.1	W/°C
T _J	Operating Junction Temperature Range	-40 to +175	°C
T _{STG}	Storage Junction Temperature Range	-40 to +175	°C
T _L	Max. Lead Temp. for Soldering (Leads at 1.6mm from case for 10s)	300	°C
T _{PKG}	Max. Lead Temp. for Soldering (Package Body for 10s)	260	°C
ESD	Electrostatic Discharge Voltage at100pF, 1500Ω	4	kV
LSD	CDM-Electrostatic Discharge Voltage at 1Ω	2	kV

Package Marking and Ordering Information

	Device Marking	Device	Package	Reel Size	Tape Width	Quantity
	FGD3245G2	FGD3245G2-F085	TO252AA	330mm	16mm	2500 units
ſ	FGB3245G2	FGB3245G2-F085	TO263AB	330mm	24mm	800 units

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
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Off State Characteristics

BV _{CER}	Collector to Emitter Breakdown Voltage	$I_{CE} = 2mA, V_{GE} = 0,$ $R_{GE} = 1K\Omega,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		420	-	480	V
BV _{CES}	Collector to Emitter Breakdown Voltage	$T_J = -40 \text{ to } 150^{\circ}\text{C}$		440	1	500	٧
BV _{ECS}	Emitter to Collector Breakdown Voltage	$I_{CE} = -75 \text{mA}, V_{GE} = 0 \text{V},$ $T_{J} = 25 ^{\circ}\text{C}$		28	-	1	V
BV _{GES}	Gate to Emitter Breakdown Voltage	I _{GES} = ±2mA		±12	±14	-	V
1	Collector to Emitter Leakage Current	V_{CE} = 250V, R_{GE} = 1K Ω	$T_J = 25^{\circ}C$	1	-	25	μΑ
ICER	Collector to Efficient Leakage Current		$T_{J} = 150^{\circ}C$	-	-	1	mA
	Emitter to Collector Leakage Current	V _{EC} = 24V,	$T_{J} = 25^{\circ}C$	-	-	1	mA
IECS	Emilier to Collector Leakage Current		$T_J = 150^{\circ}C$	-	-	40	IIIA
R ₁	Series Gate Resistance			-	120	-	Ω
R ₂	Gate to Emitter Resistance			10K	-	30K	Ω

On State Characteristics

$V_{CE(SAT)}$	Collector to Emitter Saturation Voltage	$I_{CE} = 6A, V_{GE} = 4V,$	$T_{J} = 25^{\circ}C$	•	1.13	1.25	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I_{CE} = 10A, V_{GE} = 4.5V,	$T_{J} = 150^{\circ}C$	1	1.32	1.50	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	$I_{CE} = 15A, V_{GE} = 4.5V,$	$T_{\rm J} = 150^{\rm o}{\rm C}$	-	1.64	1.85	V

Max Units

Min

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Parameter

Dynam	ic Characteristics						
Q _{G(ON)}	Gate Charge	I _{CE} = 10A, V _{CE} = 12V, V _{GE} = 5V		-	23	-	nC
V _{GE(TH)}	Gate to Emitter Threshold Voltage	I _{CE} = 1mA, V _{CE} = V _{GE,}	$T_{\rm J} = 25^{\rm o}{\rm C}$	1.3	1.6	2.2	V
V GE(TH)	Gate to Emitter Threshold Voltage		$T_{J} = 150^{\circ}C$	0.75	1.1	1.8	·
V_{GEP}	Gate to Emitter Plateau Voltage	V _{CE} = 12V, I _{CE} = 10A		-	2.7	-	V

Test Conditions

Switching Characteristics

t _{d(ON)R}	Current Turn-On Delay Time-Resistive			•	0.9	4	μS
t _{rR}	Current Rise Time-Resistive	$V_{GE} = 5V, R_{G} = 1K\Omega$ $T_{J} = 25^{\circ}C,$		1	2.6	7	μS
t _{d(OFF)L}		V _{CE} = 300V, L = 1mH,		1	5.4	15	μS
t _{fL}	Current Fall Time-Inductive	$V_{GE} = 5V, R_{G} = 1K\Omega$ $I_{CE} = 6.5A, T_{J} = 25^{\circ}C,$		-	2.7	15	μS
E _{SCIS}	I Self Clamped Inductive Switching	L = 3.0 mHy,RG = 1K Ω , VGE = 5V, (Note 1)	TJ = 25°C	-	1	320	mJ

Thermal Characteristics

$R_{\theta JC}$ Th	hermal Resistance Junction to Case	All packages	-	-	0.9	°C/W
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Notes:

Symbol

- 1: Self Clamping Inductive Switching Energy (E_{SCIS25}) of 320 mJ is based on the test conditions that starting Tj=25°C; L=3mHy, I_{SCIS} =14.6A, V_{CC} =100V during inductor charging and V_{CC} =0V during the time in clamp.
- 2: Self Clamping Inductive Switching Energy ($E_{SCIS150}$) of 180 mJ is based on the test conditions that starting Tj=150°C; L=3mHy, I_{SCIS} =10.9A, V_{CC} =100V during inductor charging and V_{CC} =0V during the time in clamp.

Typical Performance Curves

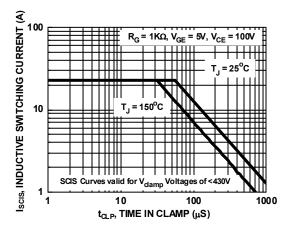


Figure 1. Self Clamped Inductive Switching Current vs. Time in Clamp

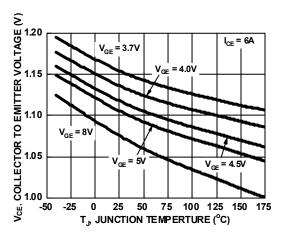


Figure 3. Collector to Emitter On-State Voltage vs. Junction Temperature

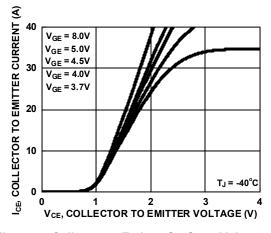


Figure 5. Collector to Emitter On-State Voltage vs. Collector Current

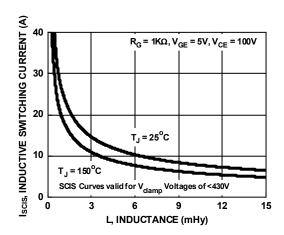


Figure 2. Self Clamped Inductive Switching Current vs. Inductance

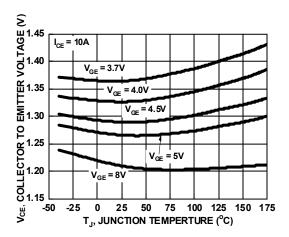


Figure 4. Collector to Emitter On-State Voltage vs. Junction Temperature

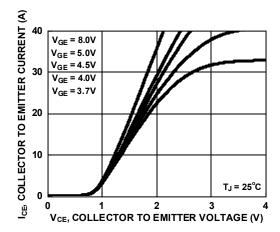


Figure 6. Collector to Emitter On-State Voltage vs. Collector Current

Typical Performance Curves (Continued)

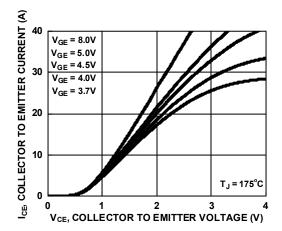


Figure 7. Collector to Emitter On-State Voltage vs. Collector Current

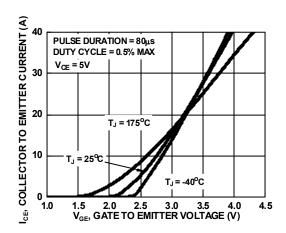


Figure 8. Transfer Characteristics

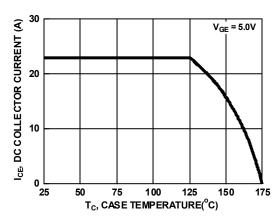


Figure 9. DC Collector Current vs. Case Temperature

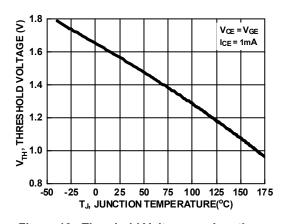


Figure 10. Threshold Voltage vs. Junction Temperature

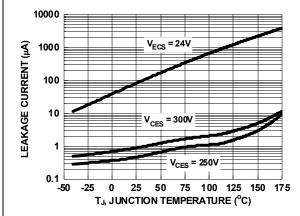


Figure 11. Leakage Current vs. Junction Temperature

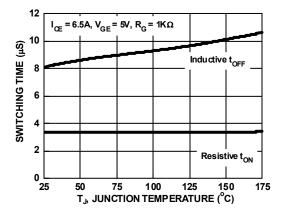
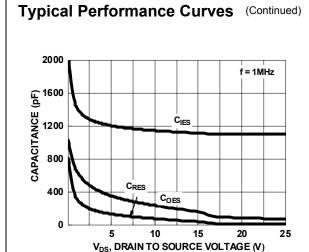


Figure 12. Switching Time vs. Junction Temperature



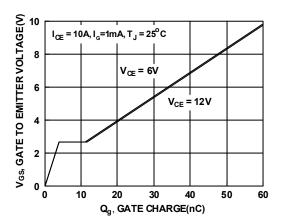


Figure 13. Capacitance vs. Collector to Emitter Voltage

Figure 14. Gate Charge

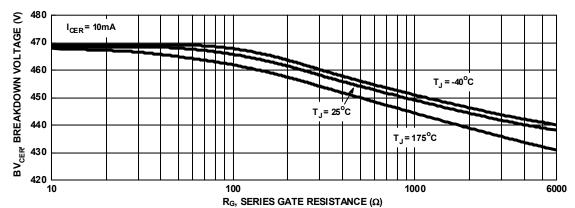


Figure 15. Break down Voltage vs. Series Gate Resistance

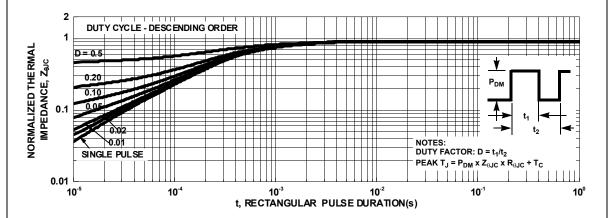
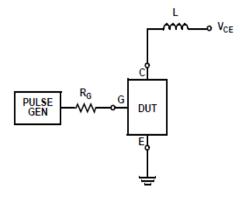


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case

Test Circuit and Waveforms



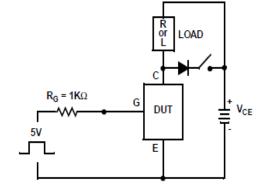
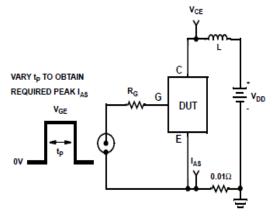
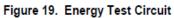


Figure 17. Inductive Switching Test Circuit

Figure 18. t_{ON} and t_{OFF} Switching Test Circuit





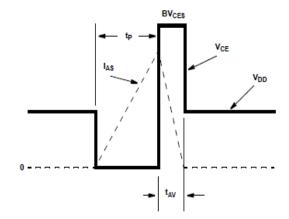


Figure 20. Energy Waveforms

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